SDLS054

SN54150, SN54151A, SN54LS151, SN54S151,
SN74150, SN74151A, SN74LS151, SN74S151
DATA SELECTORS/MULTIPLEXERS
DECEMBER 1972—REVISED MARCH 1988

- '150 Selects One-of-Sixteen Data Sources

- Others Select One-of-Eight Data Sources

- All Perform Parallel-to-Serial Conversion

- All Permit Multiplexing from N Lines to One Line

- Also For Use as Boolean Function Generator

- Input-Clamping Diodes Simplify System Design

- Fully Compatible with Most TTL Circuits

TYPE	TYPICAL AVERAGE PROPAGATION DELAY TIME DATA INPUT TO W OUTPUT	TYPICAL POWER DISSIPATION
'150	13 ns	200 mW
'151A	8 ns	145 mW
'LS151	13 ns	30 mW
'S151	4.5 ns	225 mW

description

These monolithic data selectors/multiplexers contain full on-chip binary decoding to select the desired data source. The '150 selects one-of-sixteen data sources; the '151A, 'LS151, and 'S151 select one-of-eight data sources. The '150, '151A, 'LS151, and 'S151 have a strobe input which must be at a low logic level to enable these devices. A high level at the strobe forces the W output high, and the Y output (as applicable) low.

The '150 has only an inverted W output; the '151A, 'LS151, and 'S151 feature complementary W and Y outputs.

The '151A and '152A incorporate address buffers that have symmetrical propagation delay times through the complementary paths. This reduces the possibility of transients occurring at the output(s) due to changes made at the select inputs, even when the '151A outputs are enabled (i.e., strobe low).

SN54150 . . . J OR W PACKAGE
SN74150 . . . N PACKAGE
(TOP VIEW)

E7	1	24	V_{CC}
E6	2	23	E8
E5	3	22	E9
E4	4	21	E10
E3	5	20	E11
E2	6	19	E12
E1	7	18	E13
E0	8	17	E14
$\overline{G}$	9	16	E15
W	10	15	A
D	11	14	B
GND	12	13	C
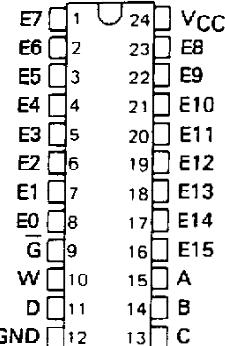
SN54151A, SN54LS151, SN54S151 . . . J OR W PACKAGE
SN74151A . . . N PACKAGE
SN74LS151, SN74S151 . . . D OR N PACKAGE
(TOP VIEW)

D3	1	16	V_{CC}
D2	2	15	D4
D1	3	14	D5
D0	4	13	D6
Y	5	12	D7
W	6	11	A
$\overline{G}$	7	10	B
GND	8	9	C
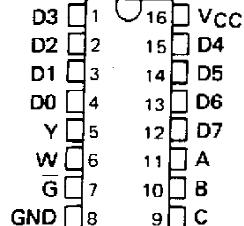
SN54LS151, SN54S151 . . . FK PACKAGE
(TOP VIEW)

Top pins: D2 (3), D3 (2), NC (1), V_{CC} (20), D4 (19)

D1	4		18	D5
D0	5		17	D6
NC	6		16	NC
Y	7		15	D7
W	8		14	A

Bottom pins: $\overline{G}$ (9), GND (10), NC (11), C (12), B (13)
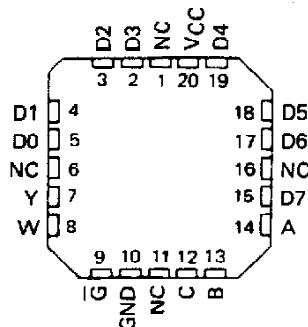
NC - No internal connection

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logic symbols†

'150

'151A, 'LS151, 'S151
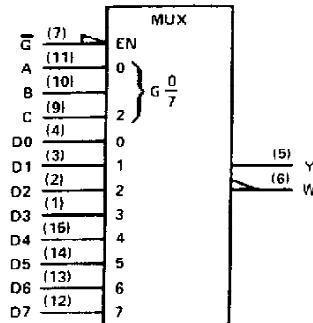
†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are D, J, N, and W packages.

'150
FUNCTION TABLE

INPUTS					OUTPUT
SELECT				STROBE	W
D	C	B	A	$\overline{G}$	
X	X	X	X	H	H
L	L	L	L	L	$\overline{E0}$
L	L	L	H	L	$\overline{E1}$
L	L	H	L	L	$\overline{E2}$
L	L	H	H	L	$\overline{E3}$
L	H	L	L	L	$\overline{E4}$
L	H	L	H	L	$\overline{E5}$
L	H	H	L	L	$\overline{E6}$
L	H	H	H	L	$\overline{E7}$
H	L	L	L	L	$\overline{E8}$
H	L	L	H	L	$\overline{E9}$
H	L	H	L	L	$\overline{E10}$
H	L	H	H	L	$\overline{E11}$
H	H	L	L	L	$\overline{E12}$
H	H	L	H	L	$\overline{E13}$
H	H	H	L	L	$\overline{E14}$
H	H	H	H	L	$\overline{E15}$

'151A, 'LS151, 'S151
FUNCTION TABLE

INPUTS				OUTPUTS	
SELECT			STROBE	Y	W
C	B	A	$\overline{G}$		
X	X	X	H	L	H
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

H = high level, L = low level, X = irrelevant
$\overline{E0}$, $\overline{E1}$ . . . $\overline{E15}$ = the complement of the level of the respective E input
D0, D1 . . . D7 = the level of the D respective input

schematics of inputs and outputs

EQUIVALENT OF EACH INPUT
OF '150

V_{CC}

4 kΩ NOM
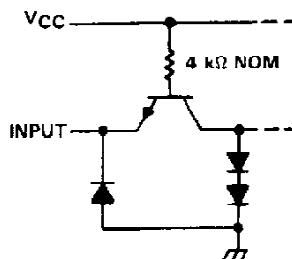
INPUT

EQUIVALENT OF EACH INPUT
OF '151A

V_{CC}

4 kΩ NOM
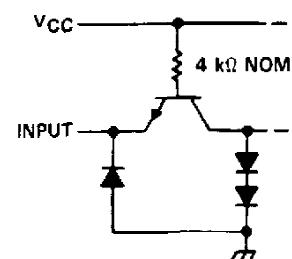
INPUT

EQUIVALENT OF EACH INPUT
OF 'LS151

V_{CC}

R_{eq}
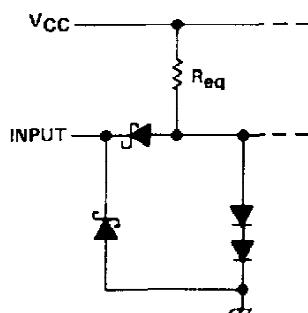
INPUT

Data select and strobe R_{eq} = 20 kΩ NOM
Data inputs R_{eq} = 17 kΩ NOM

EQUIVALENT OF EACH INPUT
OF 'S151

V_{CC}

2.8 kΩ NOM

INPUT
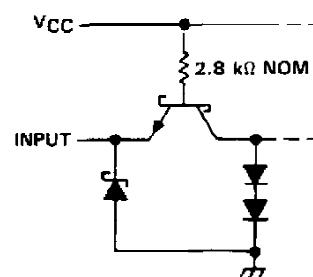
TYPICAL OF ALL OUTPUTS
OF '150, '151A

V_{CC}

130 Ω NOM
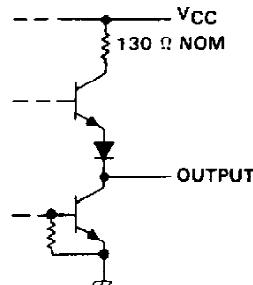
OUTPUT

TYPICAL OF ALL OUTPUTS
OF 'LS151

V_{CC}

120 Ω NOM
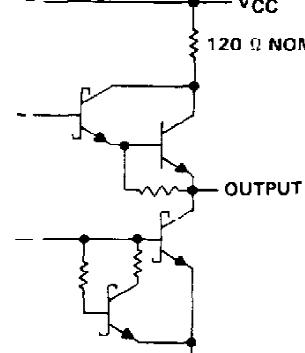
OUTPUT

TYPICAL OF ALL OUTPUTS
OF 'S151

V_{CC}

50 Ω NOM

OUTPUT

TEXAS
INSTRUMENTS

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recommended operating conditions

	SN54' MIN	NOM	MAX	SN74' MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−800			−800	μA
Low-level output current, I_{OL}			16			16	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS[†]	'150 MIN	TYP[‡]	MAX	'151A MIN	TYP[‡]	MAX	UNIT
V_{IH} High-level input voltage		2			2			V
V_{IL} Low-level input voltage				0.8			0.8	V
V_{IK} Input clamp voltage	V_{CC} = MIN, I_I = −8 mA			−1.5			−1.5	V
V_{OH} High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA	2.4	3.4		2.4	3.4		V
V_{OL} Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH} High-level input current	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IL} Low-level input current	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
I_{OS} Short-circuit output current[§] SN54'	V_{CC} = MAX	−20		−55	−20		−55	mA
I_{OS} Short-circuit output current[§] SN74'	V_{CC} = MAX	−18		−55	−18		−55	mA
I_{CC} Supply current	V_{CC} = MAX, See Note 3		40	68		29	48	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
[‡] All typical values at V_{CC} = 5 V, T_A = 25°C.
[§] Not more than one output of the '151A should be shorted at a time.
NOTE 3: I_{CC} is measured with the strobe and data select inputs at 4.5 V, all other inputs and outputs open.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER[¶]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'150 MIN	TYP	MAX	'151A MIN	TYP	MAX	UNIT
t_{PLH}	A, B, or C (4 levels)	Y						25	38	ns
t_{PHL}	A, B, or C (4 levels)	Y						25	38	ns
t_{PLH}	A, B, C, or D (3 levels)	W			23	35		17	26	ns
t_{PHL}	A, B, C, or D (3 levels)	W			22	33		19	30	ns
t_{PLH}	Strobe $\overline{G}$	Y	C_L = 15 pF, R_L = 400 Ω, See Note 4					21	33	ns
t_{PHL}	Strobe $\overline{G}$	Y						22	33	ns
t_{PLH}	Strobe $\overline{G}$	W			15.5	24		14	21	ns
t_{PHL}	Strobe $\overline{G}$	W			21	30		15	23	ns
t_{PLH}	D0 thru D7	Y						13	20	ns
t_{PHL}	D0 thru D7	Y						18	27	ns
t_{PLH}	E0 thru E15, or D0 thru D7	W			8.5	14		8	14	ns
t_{PHL}	E0 thru E15, or D0 thru D7	W			13	20		8	14	ns

[¶] t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

	SN54LS151 MIN	NOM	MAX	SN74LS151 MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−400			−400	µA
Low-level output current, I_{OL}			4			8	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS[†]	SN54LS151 MIN	TYP[‡]	MAX	SN74LS151 MIN	TYP[‡]	MAX	UNIT
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL}max, I_{OH} = −400 µA	2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL}max, I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7 V			0.1			0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7 V			20			20	µA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V			−0.4			−0.4	mA
I_{OS}	Short-circuit output current[§]	V_{CC} = MAX	−20		−100	−20		−100	mA
I_{CC}	Supply current	V_{CC} = MAX, Outputs open, All inputs at 4.5 V		6.0	10		6.0	10	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
[‡] All typical values are at V_{CC} = 5 V, T_A = 25 °C.
[§] Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A 25 °C

PARAMETER[¶]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A, B, or C (4 levels)	Y			27	43	ns
t_{PHL}					18	30	
t_{PLH}	A, B, or C (3 levels)	W			14	23	ns
t_{PHL}					20	32	
t_{PLH}	Strobe $\overline{G}$	Y	C_L = 15 pF, R_L = 2 kΩ, See Note 4		26	42	ns
t_{PHL}					20	32	
t_{PLH}	Strobe $\overline{G}$	W			15	24	ns
t_{PHL}					18	30	
t_{PLH}	Any D	Y			20	32	ns
t_{PHL}					16	26	
t_{PLH}	Any D	W			13	21	ns
t_{PHL}					12	20	

[¶] t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

SN54S151, SN74S151
DATA SELECTORS/MULTIPLEXERS

recommended operating conditions

	SN54S151			SN74S151			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−1			−1	mA
Low-level output current, I_{OL}			20			20	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS[†]		MIN	TYP[‡]	MAX	UNIT
V_{IH}	High-level input voltage			2			V
V_{IL}	Low-level input voltage					0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −18 mA				−1.2	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −1 mA	SN54S151	2.5	3.4		V
			SN74S151	2.7	3.4		
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 20 mA				0.5	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V				1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7 V				50	μA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.5 V				−2	mA
I_{OS}	Short-circuit output current[§]	V_{CC} = MAX		−40		−100	mA
I_{CC}	Supply current	V_{CC} = MAX, All inputs at 4.5 V, All outputs open			45	70	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A 25°C

PARAMETER[¶]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A, B, or C (4 levels)	Y			12	18	ns
t_{PHL}					12	18	
t_{PLH}	A, B, or C (3 levels)	W			10	15	ns
t_{PHL}					9	13.5	
t_{PLH}	Any D	Y	C_L = 15 pF,		8	12	ns
t_{PHL}			R_L = 280 kΩ,		8	12	
t_{PLH}	Any D	W	See Note 4		4.5	7	ns
t_{PHL}					4.5	7	
t_{PLH}	Strobe $\overline{G}$	Y			11	16.5	ns
t_{PHL}					12	18	
t_{PLH}	Strobe $\overline{G}$	W			9	13	ns
t_{PHL}					8.5	12	

[¶] t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
5962-9558001QJA	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type
5962-9558001QKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
5962-9558001QKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
5962-9751601Q2A	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
5962-9751601QCA	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
5962-9751601QDA	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
76010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7601001EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
7601001EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
7601001FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7601001FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
JM38510/01401BKA	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
JM38510/07901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
JM38510/07901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30901B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
JM38510/30901BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
JM38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30901BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type
SN54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type
SN54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
SN54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
SN54S151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
SN54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74150N	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74150N	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74150NE4	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74150NE4	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74151AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74151AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

PACKAGE OPTION ADDENDUM

TEXAS INSTRUMENTS

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN74LS151DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS151J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS151NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151D	NRND	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151D	NRND	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DE4	NRND	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DE4	NRND	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151DG4	NRND	SOIC	D	16	40	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
						no Sb/Br)		
SN74S151DG4	NRND	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S151N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S151NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type
SNJ54150J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type
SNJ54150W	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
SNJ54150W	ACTIVE	CFP	W	24	1	TBD	A42	N / A for Pkg Type
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S151FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S151J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type
SNJ54S151W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S15FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S15J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ54S15W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder

temperature.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54150, SN54LS151, SN54S15, SN54S151, SN74150, SN74LS151, SN74S151 :
● Catalog: SN74S15

NOTE: Qualified Version Definitions:
● Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

Reel Diameter

Reel Width (W1)
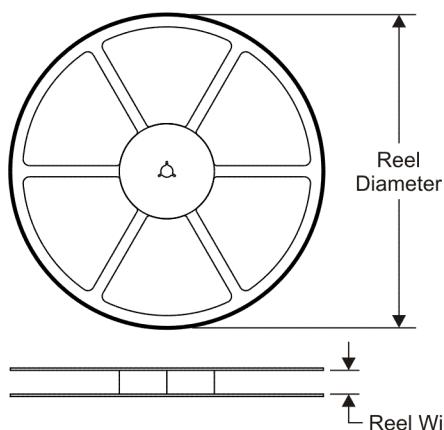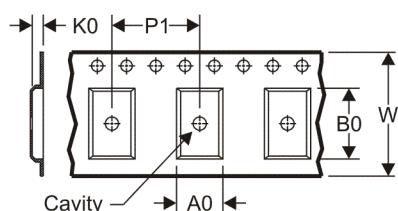
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Sprocket Holes

| Q1 | Q2 |
| Q3 | Q4 |

User Direction of Feed

Pocket Quadrants
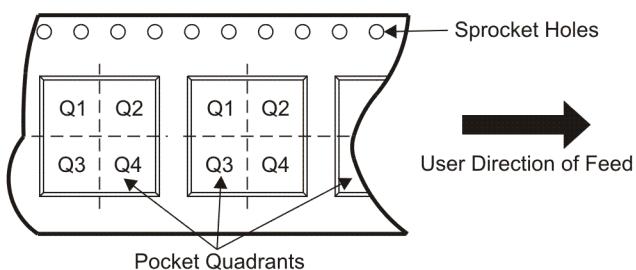
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS151DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS151NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS
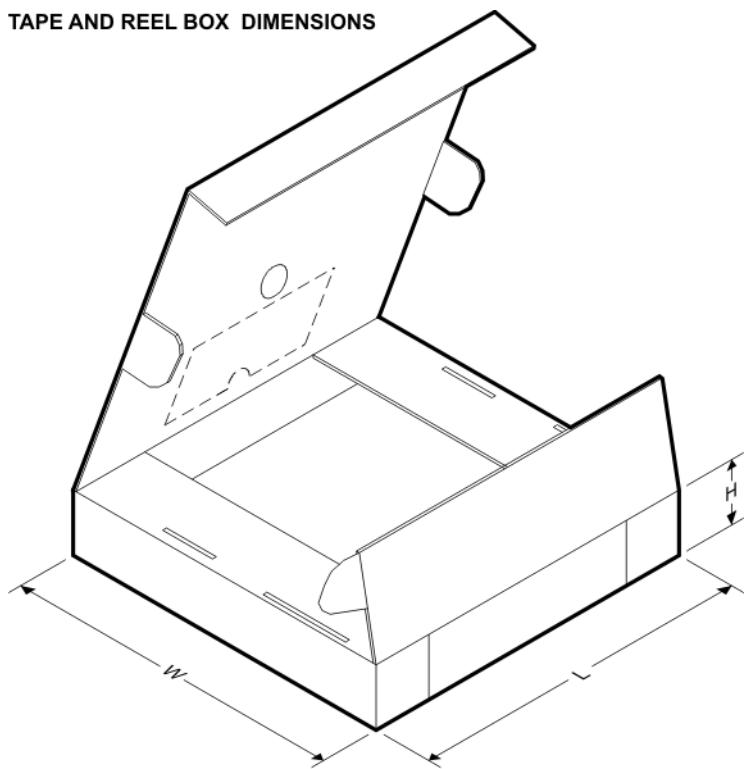
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS151DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS151NSR	SO	NS	16	2000	346.0	346.0	33.0

J (R-GDIP-T)** CERAMIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN

B

24   13

C

1   12

0.065 (1,65)
0.045 (1,14)

Lens Protrusion (Lens Optional)
0.010 (0.25) MAX

A

0.090 (2,29)
0.060 (1,53)

0.175 (4,45)
0.140 (3,56)

Seating Plane

0.018 (0,46) MIN

0.100 (2,54)

0.022 (0,56)
0.014 (0,36)

0.125 (3,18) MIN

0.012 (0,30)
0.008 (0,20)

| DIM	PINS **	24		28		32		40	
		NARR	WIDE	NARR	WIDE	NARR	WIDE	NARR	WIDE
"A"	MAX	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)
	MIN	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)
"B"	MAX	1.265(32,13)	1.265(32,13)	1.465(37,21)	1.465(37,21)	1.668(42,37)	1.668(42,37)	2.068(52,53)	2.068(52,53)
	MIN	1.235(31,37)	1.235(31,37)	1.435(36,45)	1.435(36,45)	1.632(41,45)	1.632(41,45)	2.032(51,61)	2.032(51,61)
"C"	MAX	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)
	MIN	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)

4040084/C 10/97

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).
D. This package can be hermetically sealed with a ceramic lid using glass frit.
E. Index point is provided on cap for terminal identification.
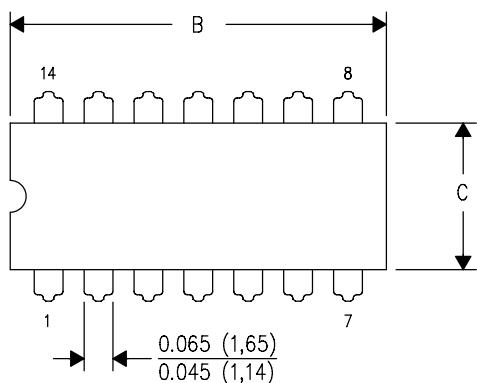
PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	——	——	——	——
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

$\dfrac{0.065\ (1,65)}{0.045\ (1,14)}$

0.005 (0,13) MIN

$\dfrac{0.060\ (1,52)}{0.015\ (0,38)}$

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

$\dfrac{0.026\ (0,66)}{0.014\ (0,36)}$

0.100 (2,54)

A

0°−15°

$\dfrac{0.014\ (0,36)}{0.008\ (0,20)}$
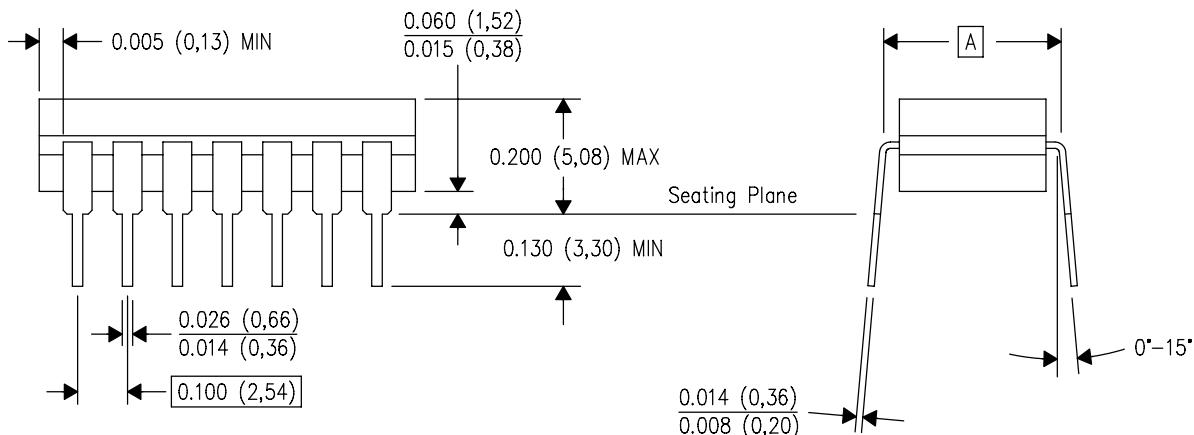
4040083/F 03/03

NOTES: A.   All linear dimensions are in inches (millimeters).
          B.   This drawing is subject to change without notice.
          C.   This package is hermetically sealed with a ceramic lid using glass frit.
          D.   Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
          E.   Falls within MIL STD 1835 GDIP1−T14, GDIP1−T16, GDIP1−T18 and GDIP1−T20.

W (R–GDFP–F16)   CERAMIC DUAL FLATPACK

Base and Seating Plane

$\dfrac{0.285\ (7,24)}{0.245\ (6,22)}$

$\dfrac{0.045\ (1,14)}{0.026\ (0,66)}$

$\dfrac{0.080\ (2,03)}{0.055\ (1,40)}$

$\dfrac{0.006\ (0,15)}{0.004\ (0,10)}$

0.305 (7,75) MAX

$\dfrac{0.019\ (0,48)}{0.015\ (0,38)}$

1   16

$\dfrac{0.430\ (10,92)}{0.370\ (9,40)}$

0.050 (1,27)

0.005 (0,13) MIN
4 Places

8   9

$\dfrac{0.360\ (9,14)}{0.250\ (6,35)}$

$\dfrac{0.360\ (9,14)}{0.250\ (6,35)}$

4040180–3/D 07/03

NOTES:
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1–F16 and JEDEC MO–092AC

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MCFP007 – OCTOBER 1994

W (R-GDFP-F24)   **CERAMIC DUAL FLATPACK**
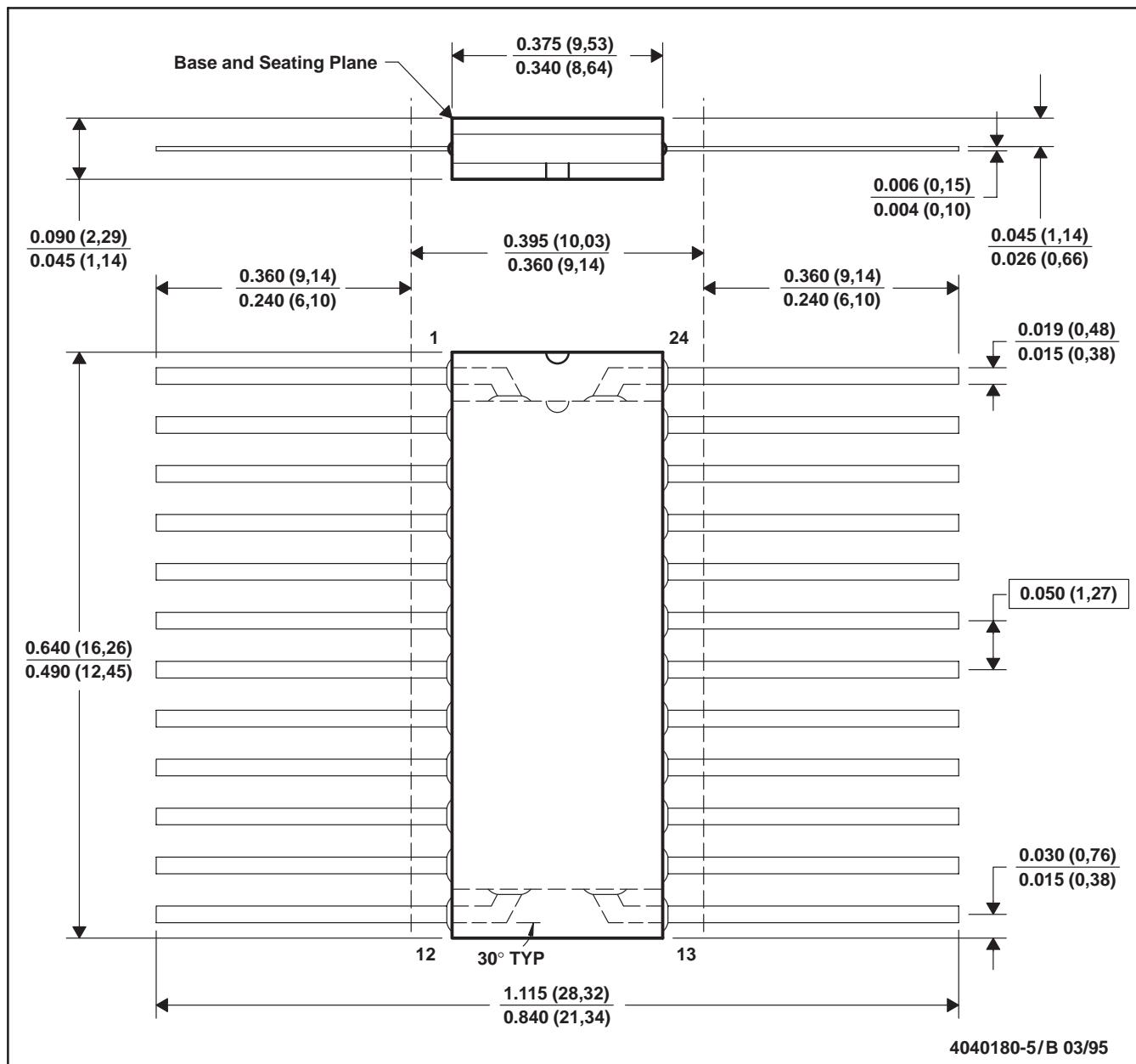
$\dfrac{0.375 (9,53)}{0.340 (8,64)}$

Base and Seating Plane

$\dfrac{0.006 (0,15)}{0.004 (0,10)}$

$\dfrac{0.090 (2,29)}{0.045 (1,14)}$

$\dfrac{0.395 (10,03)}{0.360 (9,14)}$

$\dfrac{0.045 (1,14)}{0.026 (0,66)}$

$\dfrac{0.360 (9,14)}{0.240 (6,10)}$

$\dfrac{0.360 (9,14)}{0.240 (6,10)}$

$\dfrac{0.019 (0,48)}{0.015 (0,38)}$

1   24

0.050 (1,27)

$\dfrac{0.640 (16,26)}{0.490 (12,45)}$

$\dfrac{0.030 (0,76)}{0.015 (0,38)}$

12   30° TYP   13

$\dfrac{1.115 (28,32)}{0.840 (21,34)}$

4040180-5 / B 03/95

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. This package can be hermetically sealed with a ceramic lid using glass frit.
        D. Falls within MIL-STD-1835 GDFP2-F24 and JEDEC MO-070AD
        E. Index point is provided on cap for terminal identification only.

FK (S−CQCC−N**)　　　　　LEADLESS CERAMIC CHIP CARRIER
28 TERMINAL SHOWN
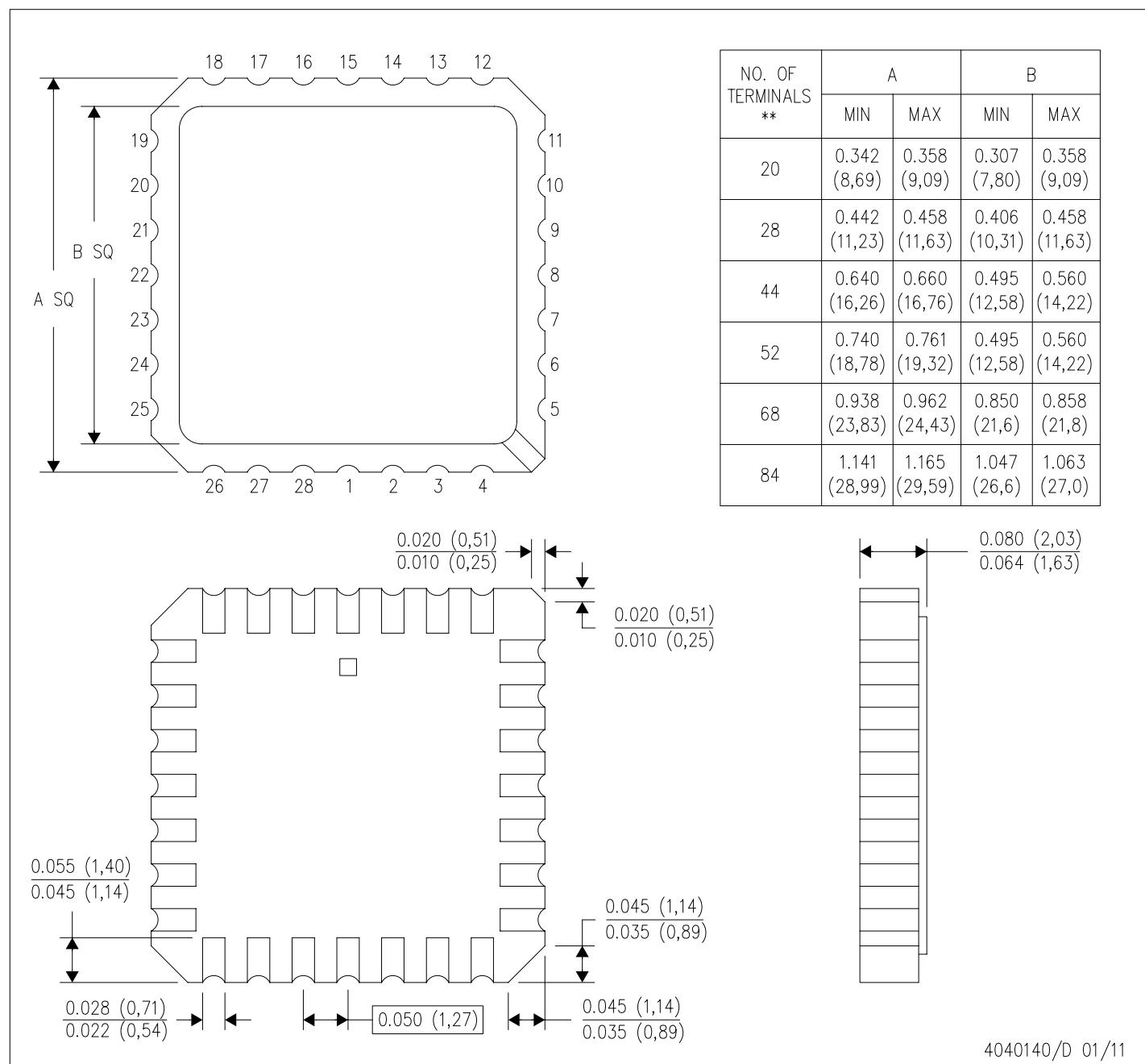
NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

4040140/D 01/11

NOTES:　A.　All linear dimensions are in inches (millimeters).
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　This package can be hermetically sealed with a metal lid.
　　　　　D.　Falls within JEDEC MS−004

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N (R−PDIP−T**)

16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE
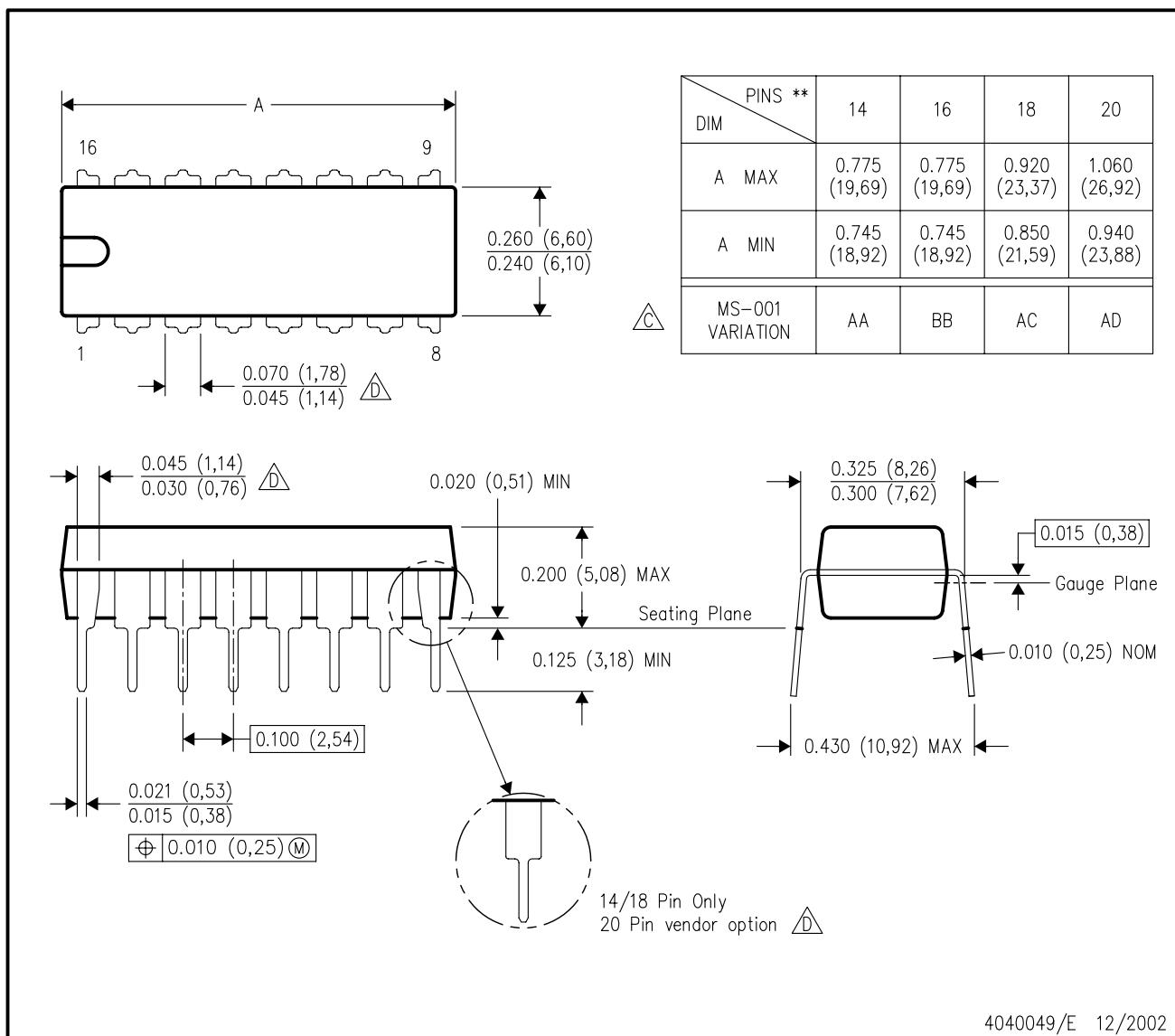
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
C MS−001 VARIATION	AA	BB	AC	AD

A

16 ... 9

$\dfrac{0.260\ (6,60)}{0.240\ (6,10)}$

1 ... 8

$\dfrac{0.070\ (1,78)}{0.045\ (1,14)}$ D

$\dfrac{0.045\ (1,14)}{0.030\ (0,76)}$ D

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

$\dfrac{0.021\ (0,53)}{0.015\ (0,38)}$

⊕ 0.010 (0,25) M

$\dfrac{0.325\ (8,26)}{0.300\ (7,62)}$

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX

14/18 Pin Only
20 Pin vendor option D

4040049/E   12/2002

NOTES: A.   All linear dimensions are in inches (millimeters).
B.   This drawing is subject to change without notice.
C.   Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
D.   The 20 pin end lead shoulder width is a vendor option, either half or full width.

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N (R–PDIP–T24)   **PLASTIC DUAL–IN–LINE**
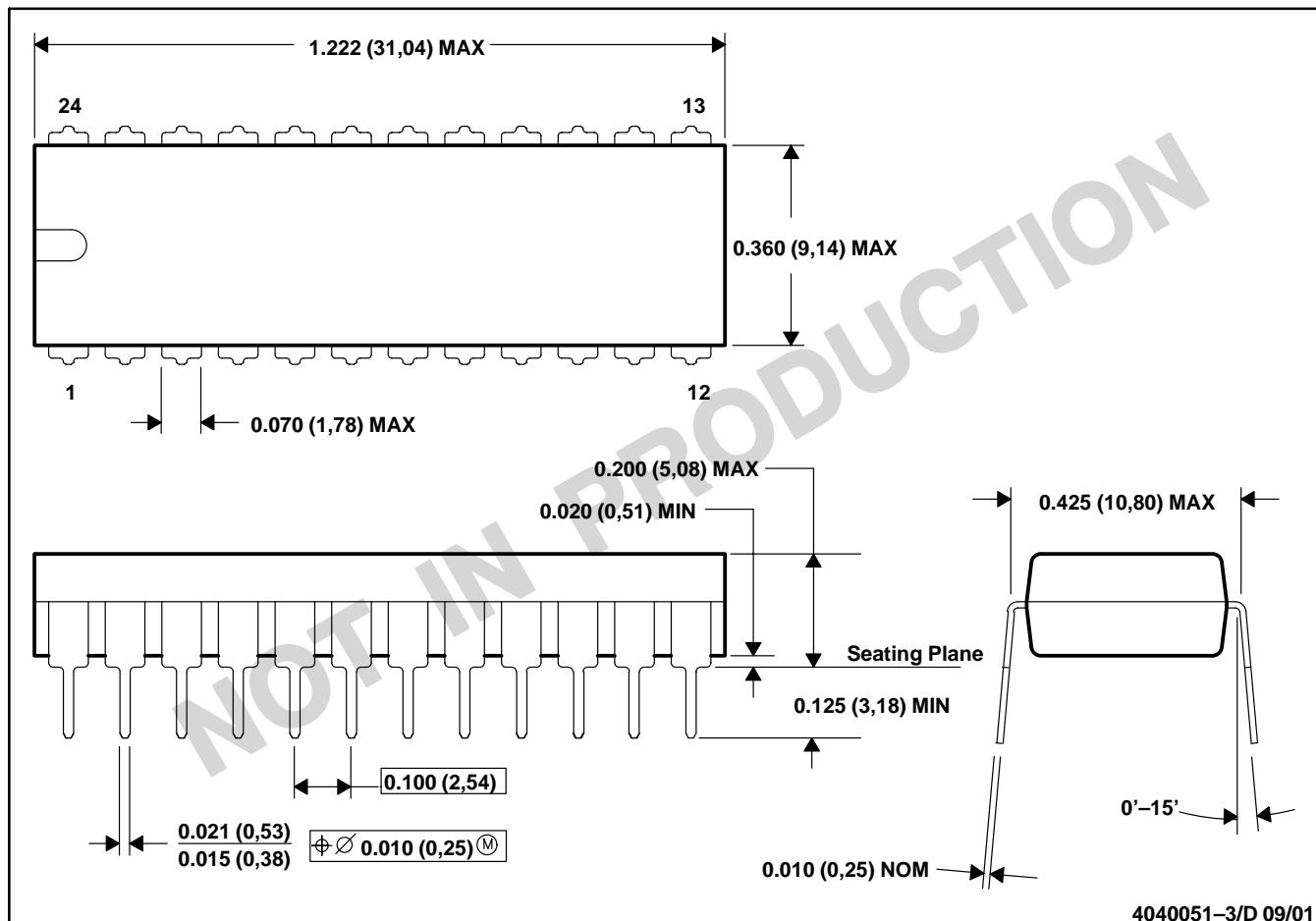
1.222 (31,04) MAX

24   13

0.360 (9,14) MAX

1   12

0.070 (1,78) MAX

0.200 (5,08) MAX

0.020 (0,51) MIN

0.425 (10,80) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53) / 0.015 (0,38)

⊕ ⌀ 0.010 (0,25) Ⓜ

0'–15'

0.010 (0,25) NOM

4040051–3/D 09/01

NOTES: A. All linear dimensions are in inches (millimeters).
            B. This drawing is subject to change without notice.
            C. Falls within JEDEC MS–010

N (R-PDIP-T**)   PLASTIC DUAL-IN-LINE PACKAGE

24 PIN SHOWN
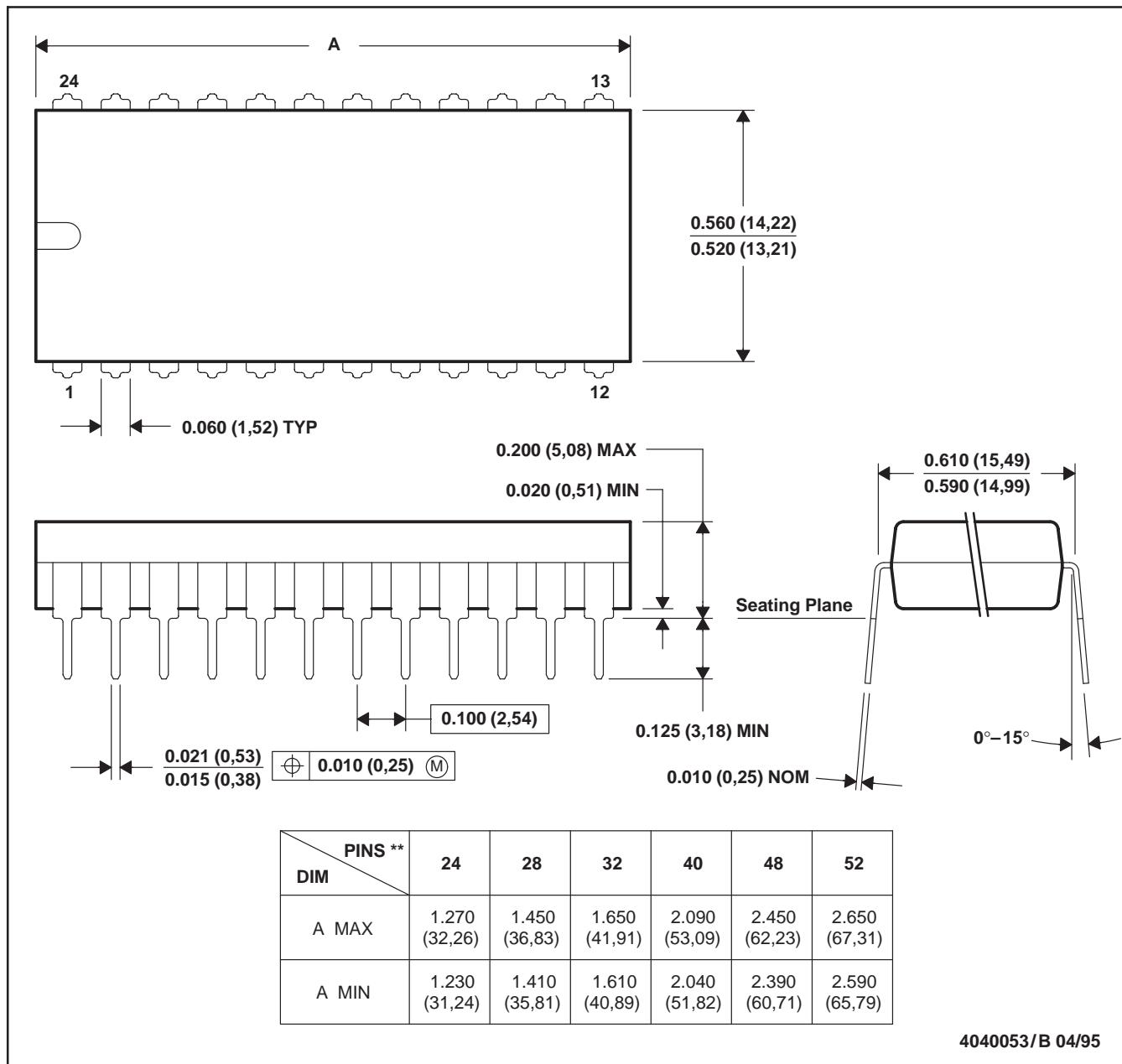
A

24   13

0.560 (14,22)
0.520 (13,21)

1   12

0.060 (1,52) TYP

0.200 (5,08) MAX

0.020 (0,51) MIN

0.610 (15,49)
0.590 (14,99)

Seating Plane

0.100 (2,54)

0.125 (3,18) MIN

0°–15°

0.021 (0,53)
0.015 (0,38)   ⊕   0.010 (0,25) Ⓜ

0.010 (0,25) NOM

PINS ** / DIM	24	28	32	40	48	52
A MAX	1.270 (32,26)	1.450 (36,83)	1.650 (41,91)	2.090 (53,09)	2.450 (62,23)	2.650 (67,31)
A MIN	1.230 (31,24)	1.410 (35,81)	1.610 (40,89)	2.040 (51,82)	2.390 (60,71)	2.590 (65,79)

4040053 / B 04/95

NOTES: A.   All linear dimensions are in inches (millimeters).
          B.   This drawing is subject to change without notice.
          C.   Falls within JEDEC MS-011
          D.   Falls within JEDEC MS-015 (32 pin only)

D (R−PDSO−G16)   PLASTIC SMALL OUTLINE

0.394 (10,00)
0.386 (9,80)
⚠C

16   9

0.244 (6,20)
0.228 (5,80)

0.157 (4,00)
0.150 (3,80) ⚠D

1   8

Pin 1
Index Area

0.050 (1,27)

0.020 (0,51)
0.012 (0,31)

⊕ 0.010 (0,25) Ⓜ

0.069 (1,75) Max

0.010 (0,25)
0.004 (0,10)

0.010 (0,25)
0.005 (0,13)

0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)   0°−8°

0.050 (1,27)
0.016 (0,40)
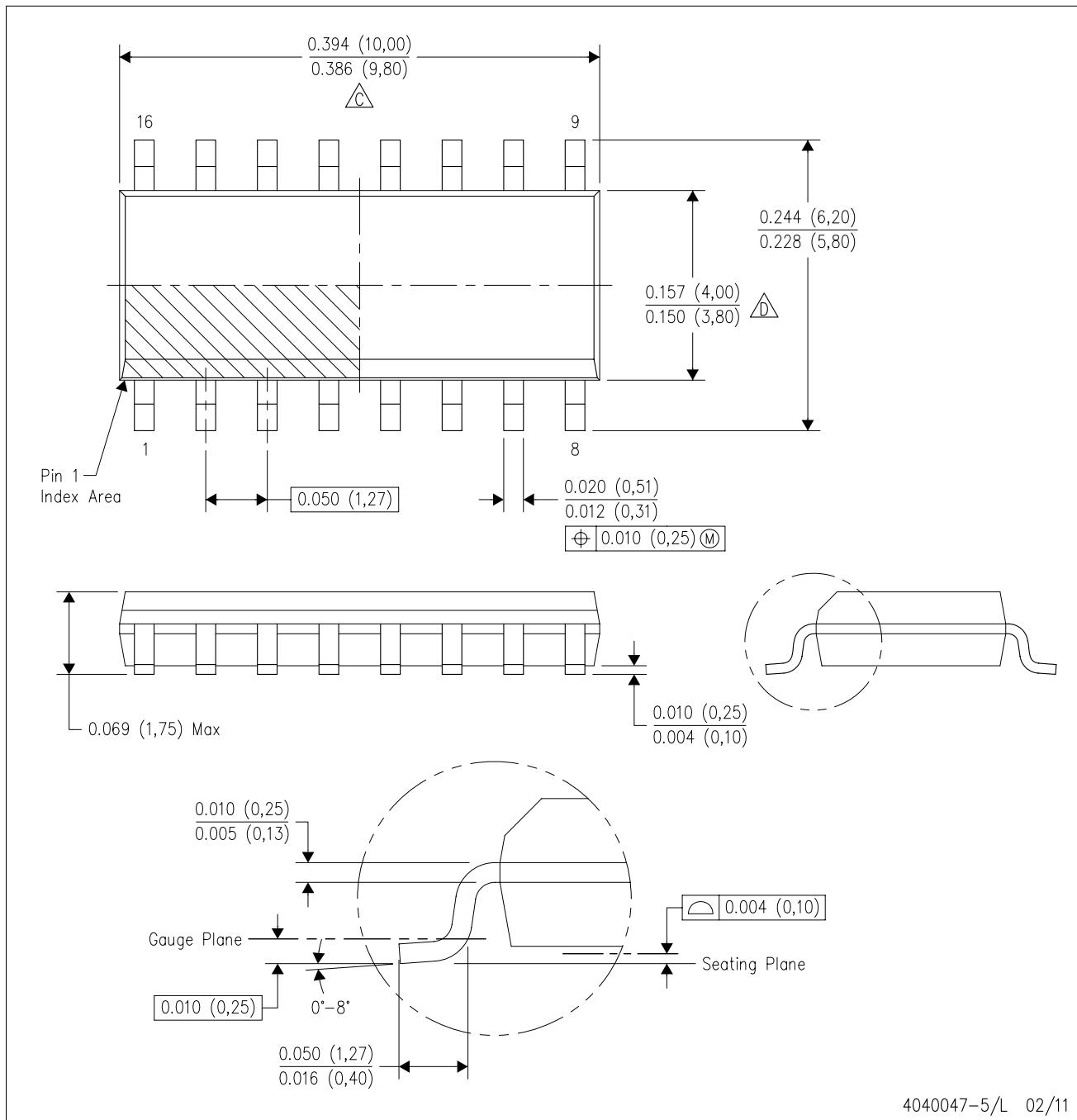
4040047−5/L   02/11

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
      ⚠C   Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall
            not exceed 0.006 (0,15) each side.
      ⚠D   Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
         E. Reference JEDEC MS−012 variation AC.

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D (R-PDSO-G16)   PLASTIC SMALL OUTLINE

Example Board Layout
(Note C)

Stencil Openings
(Note D)

14x1,27

16x0,55

16x1,95

14x1,27

4,80

4,80
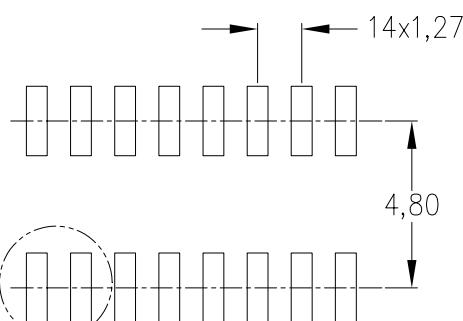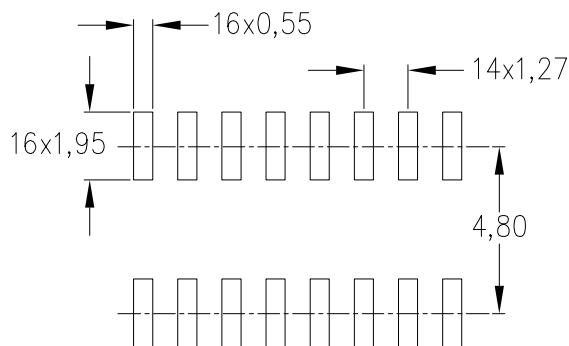
Example
Non Soldermask Defined Pad
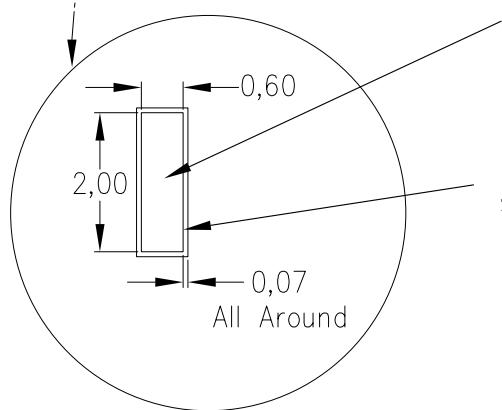
Example
Pad Geometry
(See Note C)

0,60

2,00

Example
Solder Mask Opening
(See Note E)

0,07

All Around

4211283-4/C 02/11

NOTES: A. All linear dimensions are in millimeters.
         B. This drawing is subject to change without notice.
         C. Publication IPC-7351 is recommended for alternate designs.
         D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should
             contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
         E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA
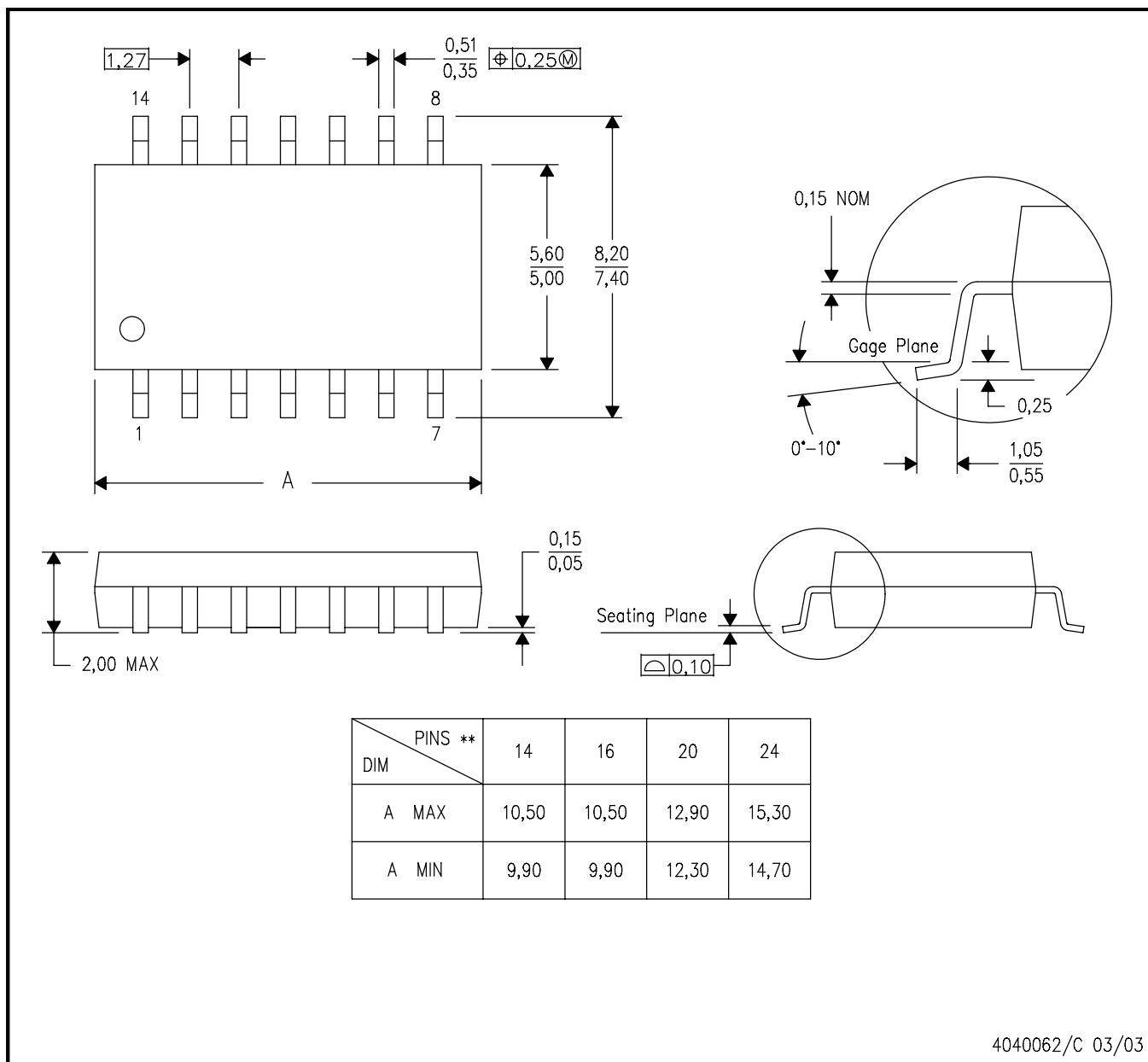
14-PINS SHOWN

DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

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NOTES: A. All linear dimensions are in millimeters.
         B. This drawing is subject to change without notice.
         C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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IMPORTANT NOTICE

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